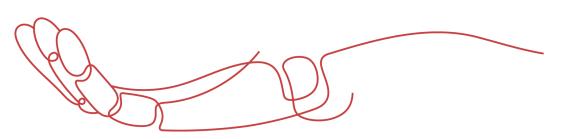


PRODUCT DATA SHEET



To learn more about JGSEMI, please visit our website at







Datasheet

Samples

Please note: Please check the JINGAO Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.jg-semi.cn. Please email any questions regarding the system integration to JINGAO_questions@jgsemi.com.



SOT-223 Plastic-Encapsulate Transistors

FEATURES

Low current : 300mA(max)High voltage: V_{CEO}=400V

MAXIMUM RATINGS (Ta=25 $^{\circ}$ C unless otherwise noted)

Symbol	Parameter Value		Unit	
V _{CBO}	Collector-Base Voltage	400	٧	
V _{CEO}	Collector-Emitter Voltage	400	V	
V _{EBO}	Emitter-Base Voltage	6	V	
Ic	Collector Current -Continuous	200	mA	
I _{CM}	Collector Current -Pulsed	300	mA	
Pc	Collector Power Dissipation	1	W	
Tj	Junction Temperature	150	°C	
T _{stg}	Storage Temperature	-65~150		

1. BASE

2. COLLECTOR

3. EMITTER

SOT-223

ELECTRICAL CHARACTERISTICS (Ta=25°C unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Тур	Max	Unit
Collector-base breakdown voltage	V _{(BR)CBO}	I _C =100μA,I _E =0	400			V
Collector-emitter breakdown voltage	V _{(BR)CEO}	I _C =1mA,I _B =0	400			V
Emitter-base breakdown voltage	V _{(BR)EBO}	I _E =100μA,I _C =0	6			V
Collector cut-off current	I _{CBO}	V _{CB} =400V,I _E =0			0.1	μΑ
Emitter cut-off current	I _{EBO}	V _{EB} =4V,I _C =0			0.1	μΑ
	h _{FE(1)}	V _{CE} =10V,I _C =1mA	40			
DC ourment agin	h _{FE(2)}	V _{CE} =10V,I _C =10mA	50		200	
DC current gain	h _{FE(3)}	V _{CE} =10V,I _C =50mA	45			
	h _{FE(4)}	V _{CE} =10V,I _C =100mA	40			
	V _{CE(sat)}	I _C =1mA,I _B =0.1mA			0.4	٧
Collector-emitter saturation voltage	V _{CE(sat)}	I _C =10mA,I _B =1mA			0.5	V
	V _{CE(sat)}	I _C =50mA,I _B =5mA			0.75	V
Base-emitter saturation voltage	V _{BE(sat)}	I _C =10mA,I _B =1mA			0.85	V
Transition frequency	f⊤	V _{CE} =10V,I _C =10mA,f=100MHz	20			MHz
Collector ca pacitance	C _C	V _{CB} =20V,I _E =0,f=1MHz			7	pF
Emitter capacitance	Ce	V _{EB} =0.5V,I _C =0,f=1MHz			180	pF



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